

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- Green Device Available

Product Summary

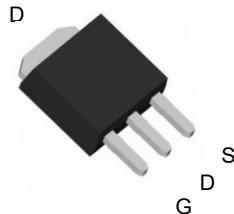


V_{DS}	30	V
I_D	70	A
$R_{DS(ON)}$ (at $V_{GS}=10V$)	6	mΩ
$R_{DS(ON)}$ (at $V_{GS}=4.5V$)	12	mΩ

Applications

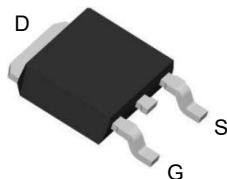
- High Frequency Point-of-Load,Synchronous Buck Converter
- Networking DC-DC Power System
- Load Switch

TO-251 Top View

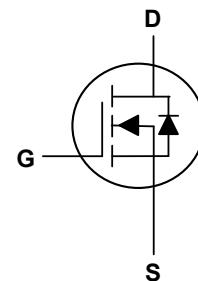


AT03700C

TO-252 Top View



AT03700K



Absolute Maximum Ratings($T_c=25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Rating	Units
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current ¹	I_D	70	A
Continuous Drain Current ¹	I_D	44	A
Pulsed Drain Current ²	I_{DM}	280	A
Single Pulse Avalanche Energy ³	EAS	110	mJ
Total Power Dissipation ⁴	P_D	60	W
Storage Temperature Range	T_{STG}	-55 to 150	°C
Operating Junction Temperature Range	T_J	-55 to 150	°C

Thermal Characteristics

Parameter	Symbol	Typ	Max	Unit
Thermal Resistance Junction-Case ¹	$R_{\theta JC}$	---	2.3	°C/W

Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}}=0\text{V}$, $I_D=250\mu\text{A}$	30	---	---	V
Static Drain-Source On-Resistance	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}}=10\text{V}$, $I_D=30\text{A}$	---	4.8	6.0	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}$, $I_D=20\text{A}$	---	7.5	12	$\text{m}\Omega$
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{GS}}=V_{\text{DS}}$, $I_D=250\mu\text{A}$	1.0	1.5	2.5	V
Drain-Source Leakage Current	I_{DSS}	$V_{\text{DS}}=30\text{V}$, $V_{\text{GS}}=0\text{V}$, $T_J=25^\circ\text{C}$	---	---	1	μA
Gate-Source Leakage Current	I_{GSS}	$V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$	---	---	± 100	nA
Forward Transconductance	g_{fs}	$V_{\text{DS}}=10\text{V}$, $I_D=10\text{A}$	---	20	---	S
Total Gate Charge	Q_g	$V_{\text{DS}}=15\text{V}$, $V_{\text{GS}}=4.5\text{V}$, $I_D=20\text{A}$	---	33	---	nC
Gate-Source Charge	Q_{gs}		---	5.5	---	
Gate-Drain Charge	Q_{gd}		---	7.5	---	
Turn-On Delay Time	$T_{\text{d}(\text{on})}$	$V_{\text{DD}}=15\text{V}$, $I_D=20\text{A}$, $V_{\text{GS}}=10\text{V}$, $R_G=3.3\Omega$	---	21	---	ns
Rise Time	T_r		---	11	---	
Turn-Off Delay Time	$T_{\text{d}(\text{off})}$		---	30	---	
Fall Time	T_f		---	9.5	---	
Input Capacitance	C_{iss}	$V_{\text{DS}}=15\text{V}$, $V_{\text{GS}}=0\text{V}$, $f=1\text{MHz}$	---	2050	---	pF
Output Capacitance	C_{oss}		---	365	---	
Reverse Transfer Capacitance	C_{rss}		---	225	---	

Drain-Source Diode Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Continuous Source Current ¹	I_s	$V_G=V_D=0\text{V}$, Force Current	---	---	70	A
Diode Forward Voltage ²	V_{SD}	$V_{\text{GS}}=0\text{V}$, $I_s=30\text{A}$, $T_J=25^\circ\text{C}$	---	0.8	1.3	V
Reverse Recovery Time	t_{rr}	$I_F=30\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$, $T_J=25^\circ\text{C}$	---	33	---	nS
	Q_{rr}		---	15	---	nC

Note:

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
2. The data tested by pulsed , pulse width $\leq 300\text{us}$, duty cycle $\leq 2\%$
3. The EAS data shows Max. rating . The test condition is $V_{\text{DD}}=15\text{V}$, $V_{\text{GS}}=10\text{V}$, $L=0.5\text{mH}$
4. The power dissipation is limited by 150°C junction temperature

Typical Characteristics

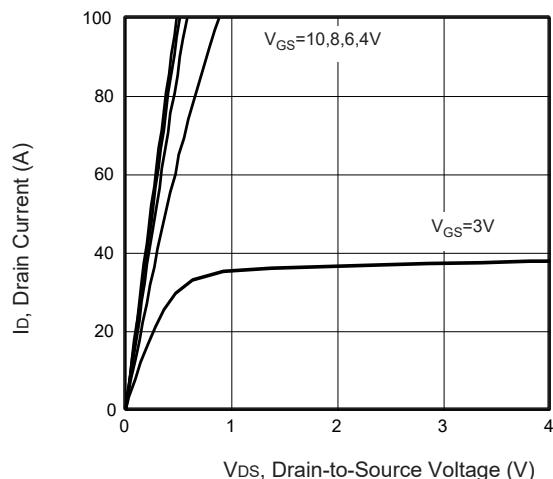


Figure 1. Output Characteristics

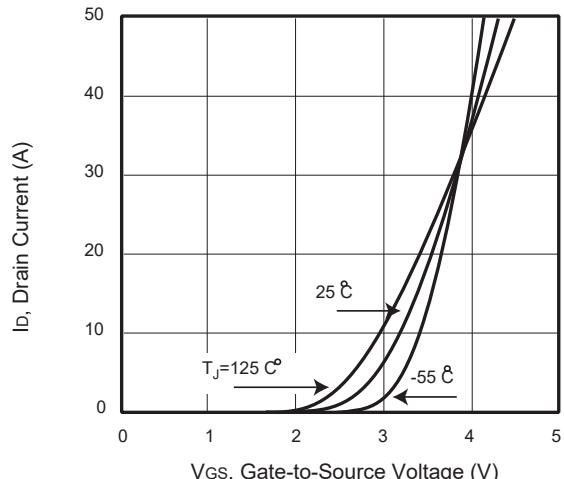


Figure 2. Transfer Characteristics

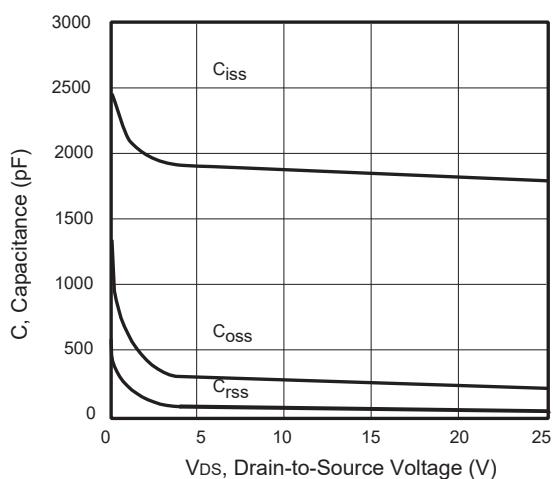


Figure 3. Capacitance

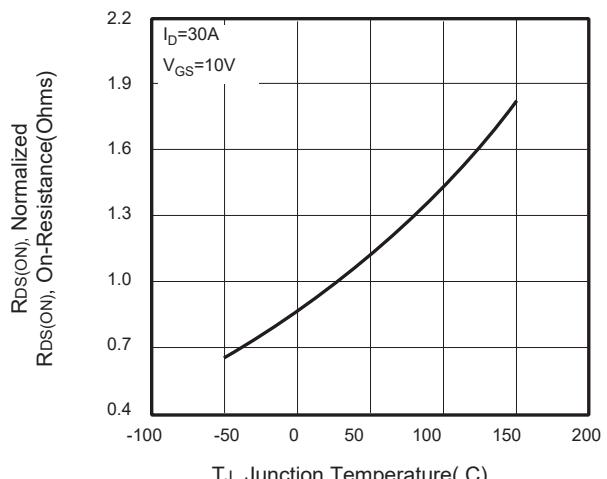


Figure 4. On-Resistance Variation with Temperature

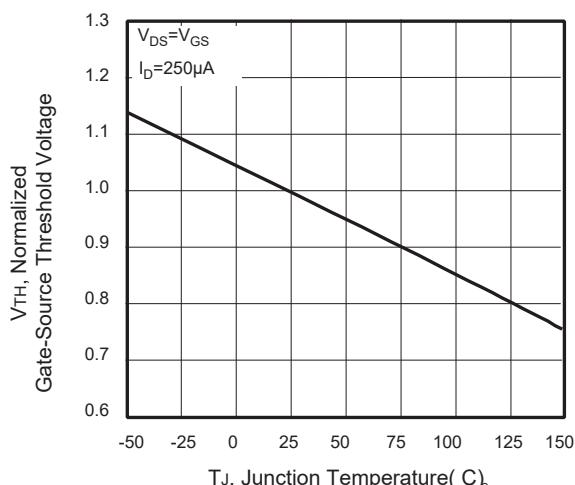


Figure 5. Gate Threshold Variation with Temperature

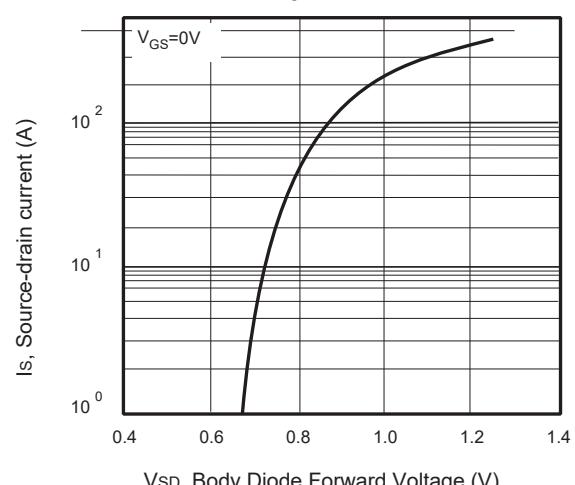


Figure 6. Body Diode Forward Voltage Variation with Source Current

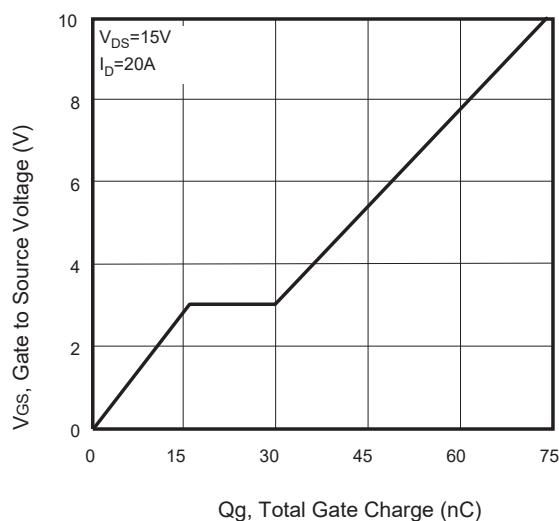


Figure 7. Gate Charge

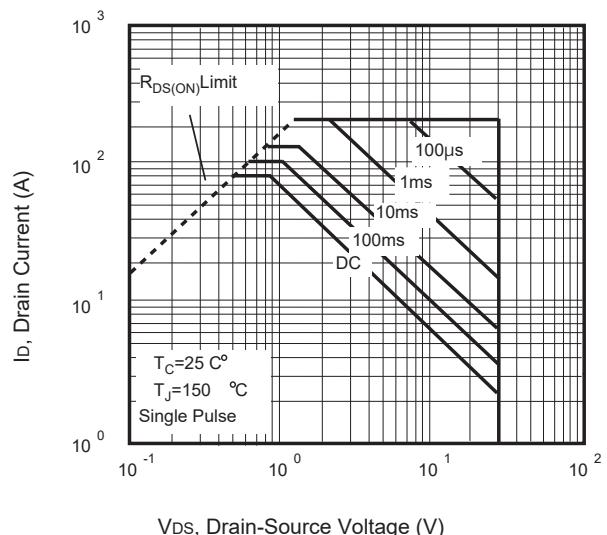


Figure 8. Maximum Safe Operating Area

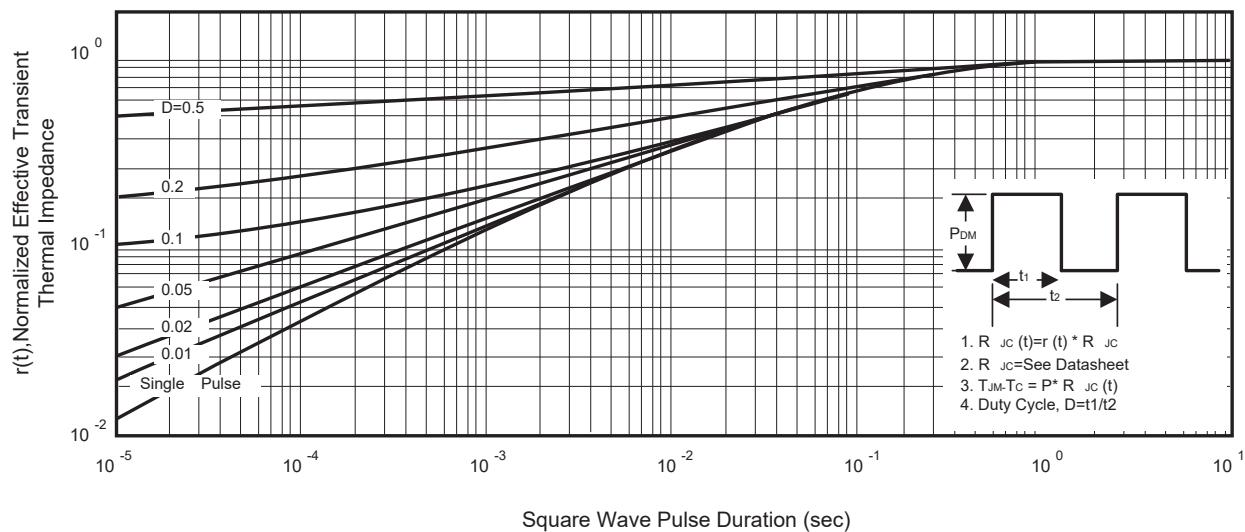
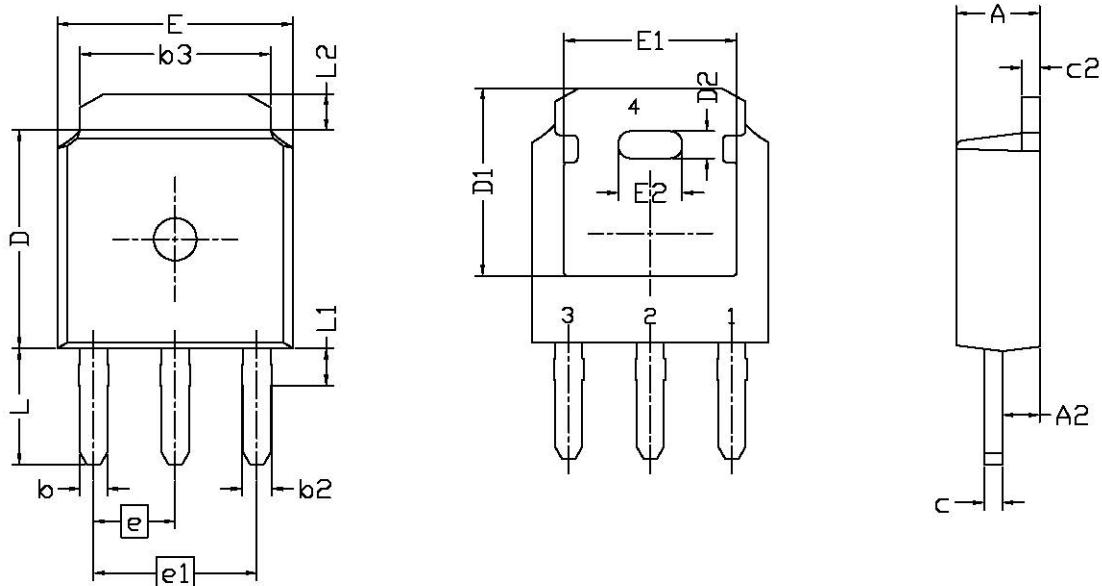


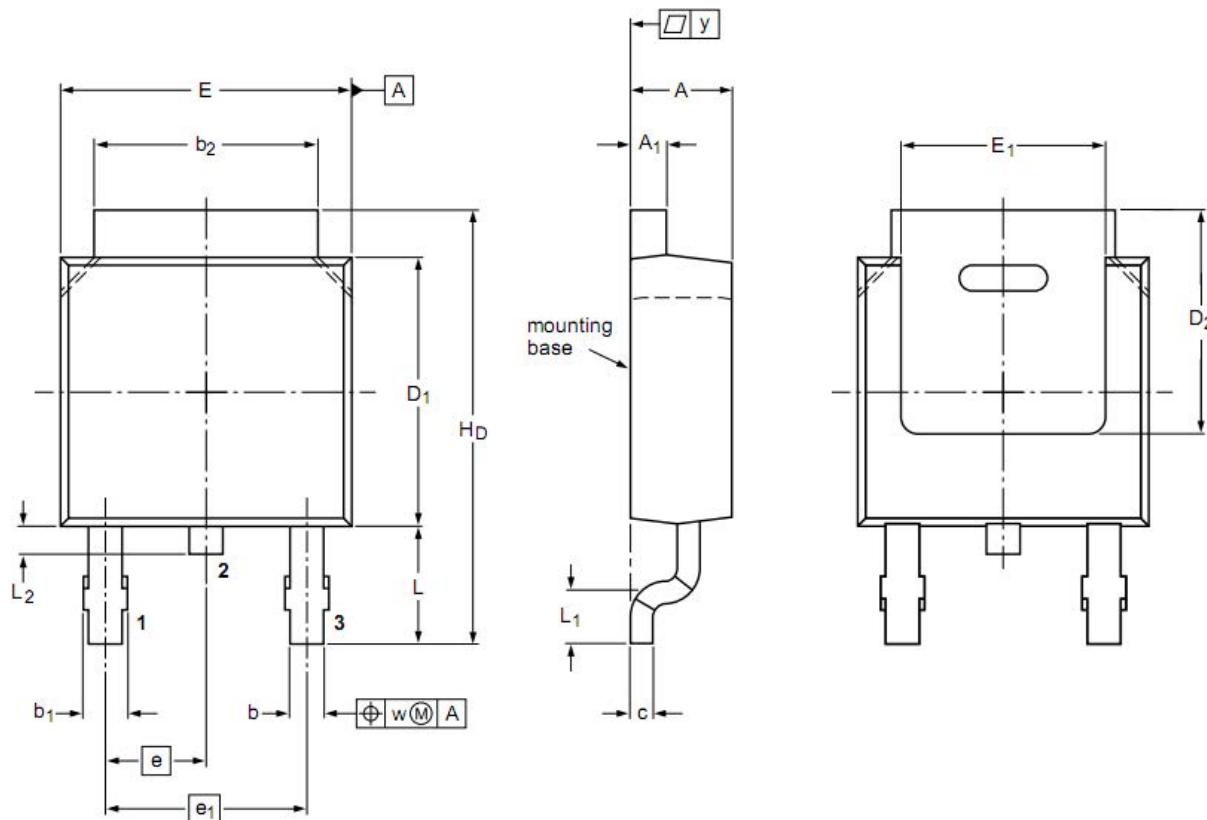
Figure 9. Normalized Thermal Transient Impedance Curve

TO-251 Package Outline Dimensions



Symbol	Dimensions (unit:mm)			Symbol	Dimensions (unit:mm)		
	Min	Typ	Max		Min	Typ	Max
A	2.20	2.30	2.39	A2	0.90	1.00	1.14
b	0.63	0.76	0.85	b2	0.76	0.85	1.05
b3	5.10	5.40	5.60	C	0.46	0.51	0.61
C2	0.46	0.51	0.61	D	5.90	6.10	6.30
D1	5.25 REF			D2	0.508 BSC		
E	6.35	6.55	6.70	E1	5.06 REF		
E2	1.524 BSC			e	2.29 BSC		
e1	4.57 BSC			L	3.70	4.00	4.40
L1	1.15 REF			L2	0.90	1.06	1.20

TO-252 Package Outline Dimensions



Symbol	Dimensions (unit:mm)			Symbol	Dimensions (unit:mm)		
	Min	Typ	Max		Min	Typ	Max
A	2.20	2.30	2.38	E₁	4.40	--	--
A₁	0.46	0.50	0.63	e	2.286 BSC		
b	0.64	0.76	0.89	e₁	--	4.57	--
b₁	0.77	0.85	1.14	H_D	9.40	10.00	10.40
b₂	5.00	5.33	5.46	L	2.743 REF		
c	0.458	0.508	0.558	L₁	1.40	1.52	1.77
D₁	5.98	6.10	6.223	L₂	0.50	0.80	1.01
D₂	5.21	--	--	W	--	0.20	--
E	6.40	6.60	6.731	y	--	--	0.20